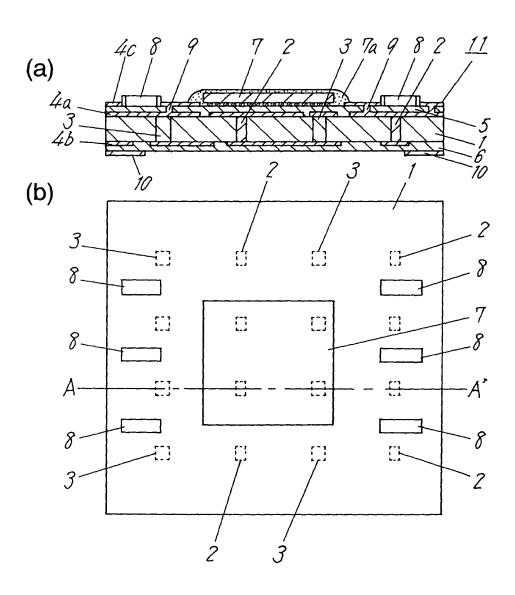
FIG. 1



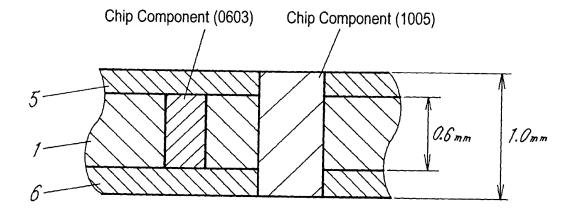


FIG. 3

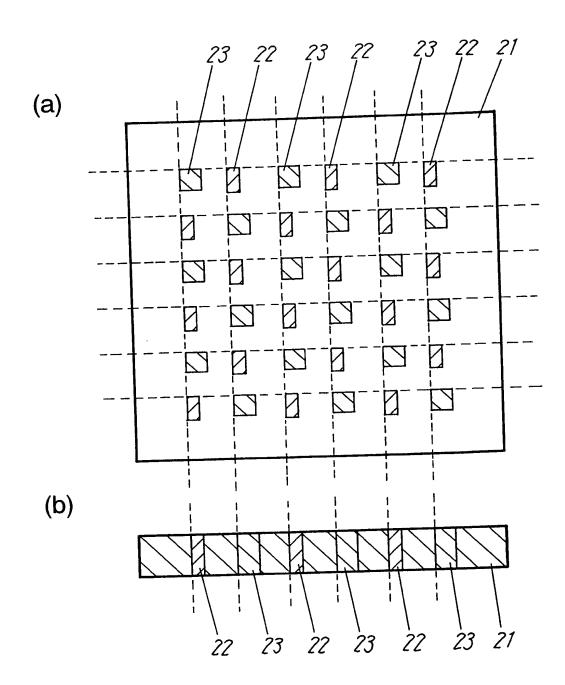
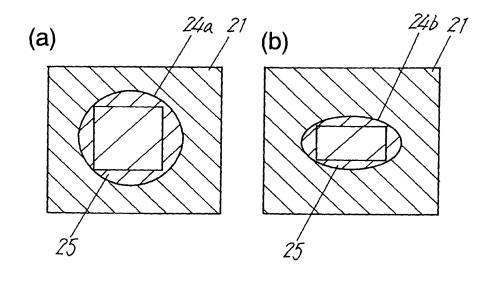


FIG. 4



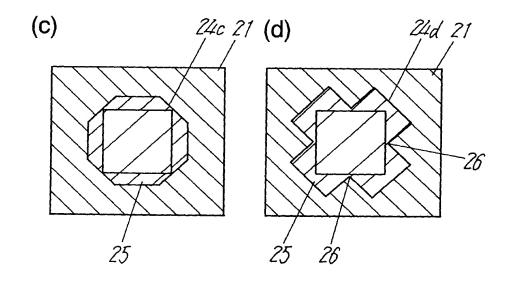
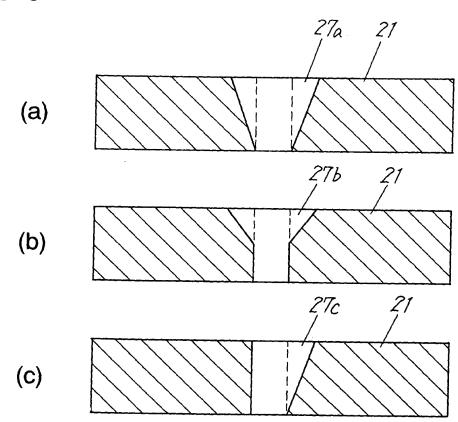


FIG. 5



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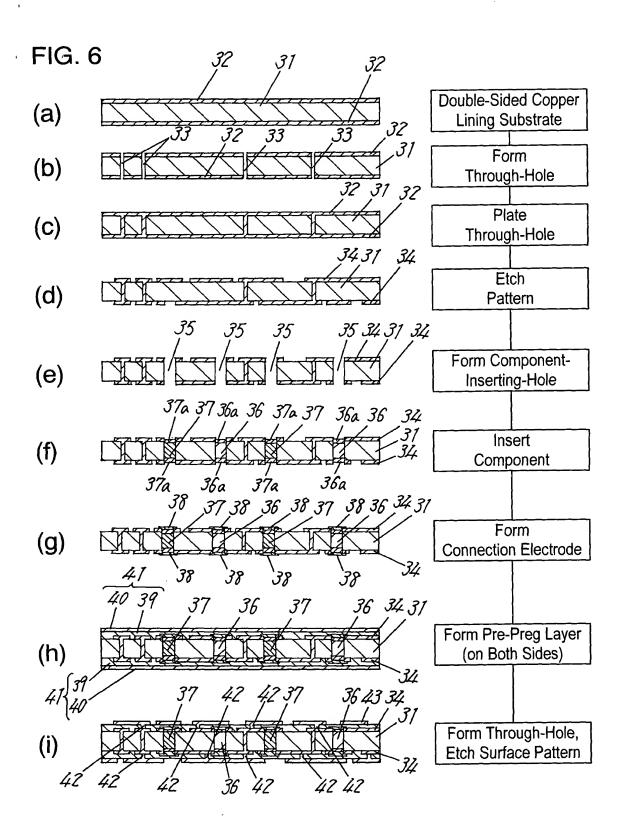


FIG. 7

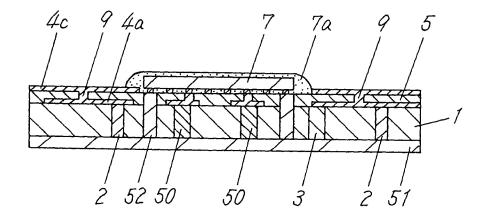
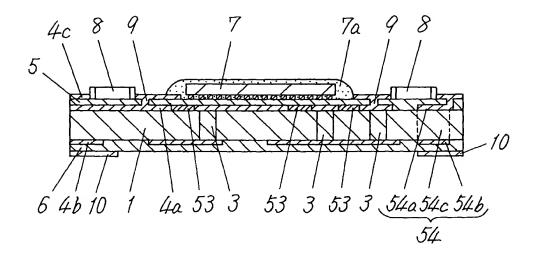


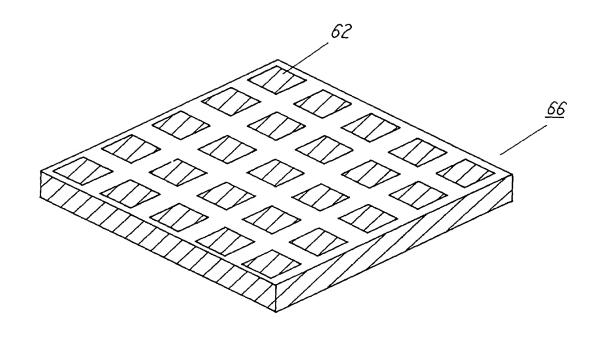
FIG. 8



<u>66</u>

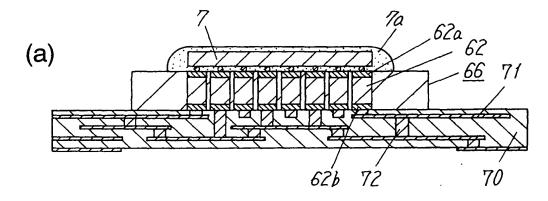
FIG. 9 62a , 62 63 62b 61a Insert (a) Chip Component 64a -61b Die-Form (b) **Primary Molding** -61b Primary (c) Molding `65a 610 616 Peel off Chip-Component-(d) Û Inserting-Side Die 65a 61a 63 65a 616 Die-Form (e) Secondary Molding 64b `61c Secondary **(f)** Molding 616 61c 65a 65b Peel off Die, 65a (g) Form Component 65b

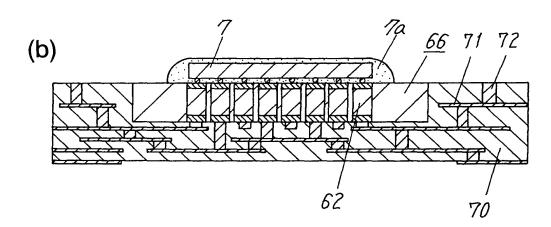
FIG. 10



by had given by given by the way they had he decided the

FIG. 11





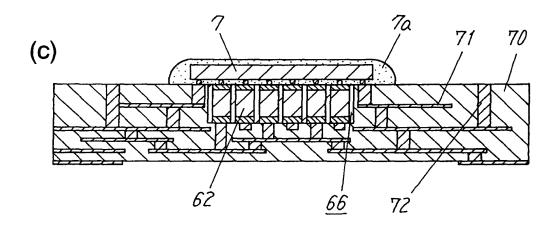


FIG. 12

